CLAIMS

- 1. A method for cleaning a surface of a substrate, which comprises at least the following steps (1) and (2), wherein the step (2) is carried out after carrying out the step (1):
- Step (1): A cleaning step of cleaning the surface of the substrate with an alkaline cleaning agent containing a complexing agent, and
- Step (2): A cleaning step employing a cleaning agent

 having a hydrofluoric acid content C (wt%) of from 0.03

 to 3 wt%, wherein the cleaning time t (seconds) of the

 substrate with said cleaning agent is at most 45 seconds,

 and C and t satisfy the relationship of 0.25<tC^{1.29}<5.
 - 2. The method for cleaning a surface of a substrate according to Claim 1, wherein the complexing agent is a compound having nitrogen as a donor atom, and a carboxyl group and/or a phosphonic acid group.

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- 3. The method for cleaning a surface of a substrate according to Claim 2, wherein the complexing agent is a compound having an aromatic hydrocarbon ring, and at least two OH groups and/or O groups directly bonded to carbon atoms constituting said ring.
- 4. The method for cleaning a surface of a substrate according to Claim 3, wherein the complexing agent is one or more selected from the group consisting of ethylenediamine tetracetic acid (EDTA), ethylenediamine di-o-hydroxyphenylacetic acid (EDDHA) and/or its

derivatives, diethylenetriamine pentacetic acid (DTPA), and propylenediamine tetra(methylenephosphonic acid) (PDTMP).

- 5. The method for cleaning a surface of a substrate according to Claim 1, wherein the concentration of the complexing agent in the cleaning agent used in the step (1) is from 1 to 10,000 wt ppm.
- 6. The method for cleaning a surface of a substrate according to Claim 1, wherein the cleaning agent used in the step (1) contains ammonium hydroxide.
- 7. The method for cleaning a surface of a substrate according to Claim 6, wherein the pH of the cleaning agent used in the step (1) is at least 9.

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- 8. An apparatus for cleaning a surface of a substrate, characterized by employing the method for cleaning a surface of a substrate as defined in Claim 1.
- 9. A method for cleaning a surface of a substrate, which comprises at least the following steps (2) and (3), wherein the step (3) is carried out after carrying out the step (2):
- Step (2): A cleaning step employing a cleaning agent having a hydrofluoric acid content C (wt%) of from 0.03 to 3 wt%, wherein the cleaning time t (seconds) of the substrate with said cleaning agent is at most 45 seconds, and C and t satisfy the relationship of $0.25 \le tC^{1.29} \le 5$, and
 - Step (3): A cleaning step of cleaning the surface of

the substrate with an alkaline cleaning agent.

- 10. The method for cleaning a surface of a substrate according to Claim 9, wherein the cleaning agent used in the step (3) contains a complexing agent.
- 11. The method for cleaning a surface of a substrate according to Claim 10, wherein the complexing agent is a compound having nitrogen as a donor atom, and a carboxyl group and/or a phosphonic acid group.
- 12. The method for cleaning a surface of a substrate

 10 according to Claim 11, wherein the complexing agent is a

 compound having an aromatic hydrocarbon ring, and at

 least two OH groups and/or O groups directly bonded to

 carbon atoms constituting said ring.
- 13. The method for cleaning a surface of a substrate

 15 according to Claim 12, wherein the complexing agent is

 one or more selected from the group consisting of

 ethylenediamine tetracetic acid (EDTA), ethylenediamine

 di-o-hydroxyphenylacetic acid (EDDHA) and/or its

 derivatives, diethylenetriamine pentacetic acid (DTPA),

 20 and propylenediamine tetra(methylenephosphonic acid)

 (PDTMP).
 - 14. The method for cleaning a surface of a substrate according to Claim 10, wherein the concentration of the complexing agent in the cleaning agent used in the step
- 25 (3) is from 1 to 10,000 wt ppm.
 - 15. The method for cleaning a surface of a substrate according to Claim 9, wherein the cleaning agent used in

the step (3) contains ammonium hydroxide.

- 16. The method for cleaning a surface of a substrate according to Claim 15, wherein the pH of the cleaning agent used in the step (3) is at least 9.
- 17. An apparatus for cleaning a surface of a substrate, characterized by employing the method for cleaning a surface of a substrate as defined in Claim 9.